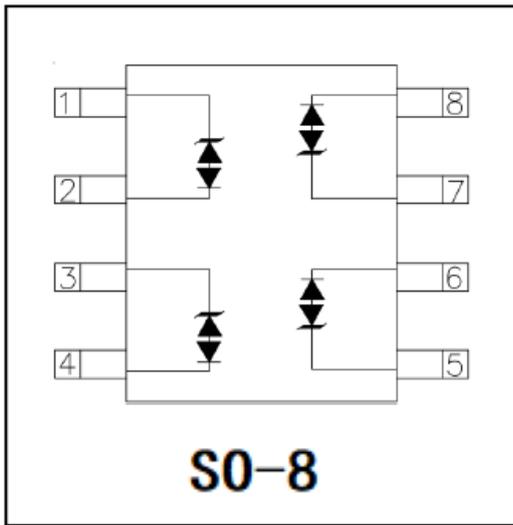
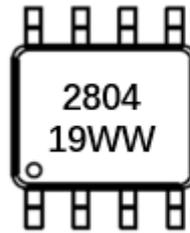


ESD Protection Diode



Features

- Protects two line pairs (four lines)
- Ultra low leakage: nA level
- Low operating voltage: 2.8V
- Moisture Sensitivity: Level 3 per J-STD-020
- JEDEC SO-8 package
- Marking:



2804 = Device Marking Code
Dot denotes Pin1

■ Maximum Ratings (TA=25°C unless otherwise specified)

PARAMETER	SYMBOL	VALUE	UNIT
Operating Temperature Range	T _J	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C
IEC61000-4-2(ESD)Air	V _{ESD}	±30	KV
IEC61000-4-2(ESD)Contact		±30	KV
Peak Pulse Power	P _{PK}	100	W
Peak Pulse Current	I _{PP}	10	A

■ Electrical Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse Working Voltage	V _{RWM}	V				2.8
Reverse Leakage Current	I _R	uA	V _{RWM} =2.8V			0.05
Punch-Through Voltage	V _(PT)	V	I _T =2uA	3.5		
Snap-Back Voltage	V _(SB)	V	I _T =50mA	2.8		
Clamping Voltage	V _C	V	I _{PP} =1A(8 x 20μs pulse)			5.5
Clamping Voltage	V _C	V	I _{PP} =10A(8 x 20μs pulse)			10
Variation in Capacitance With reverse Bias		pF	Pin 1,8 to 2,7 and 3,6 to 4,5 V _R =0 to 2.8V f=1MHz		1.3	
Junction Capacitance	C _J	pF	Pin 1,8 to 2,7 and 3,6 to 4,5 V _R = 2.8V f=1MHz		4.5	6

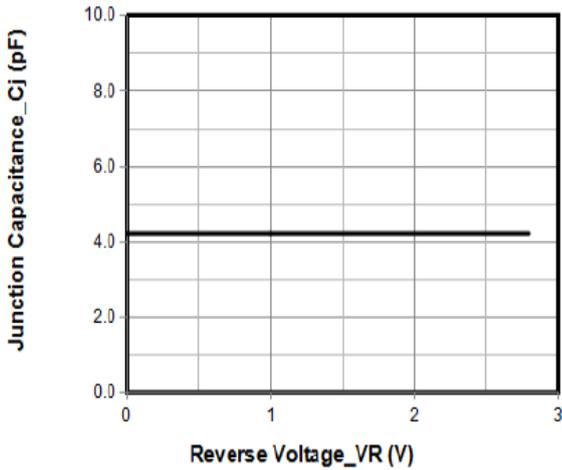


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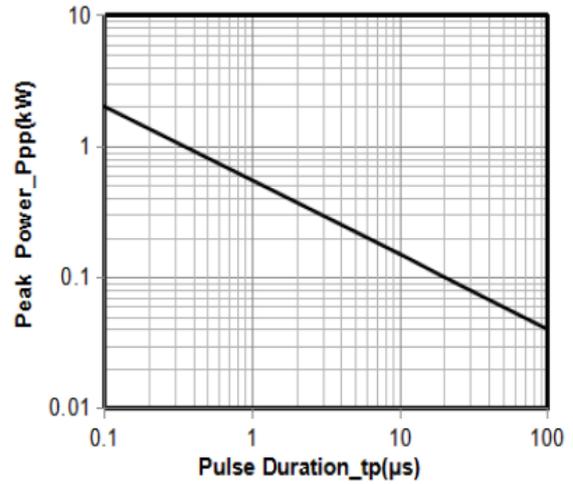
■ Thermal Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	AU2804S8
Thermal Resistance(Typical)	R _{θJ-A}	°C/W	184
	R _{θJ-C}	°C/W	74

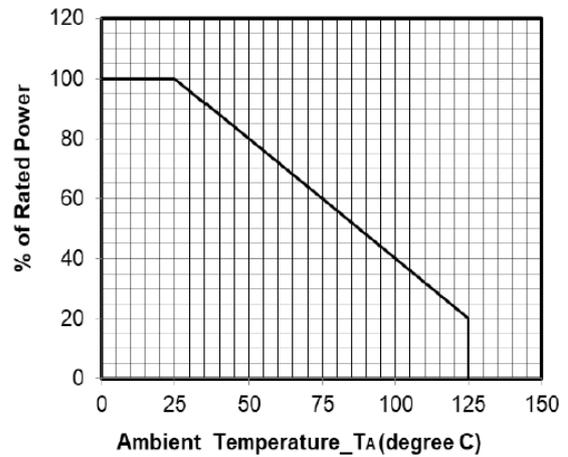
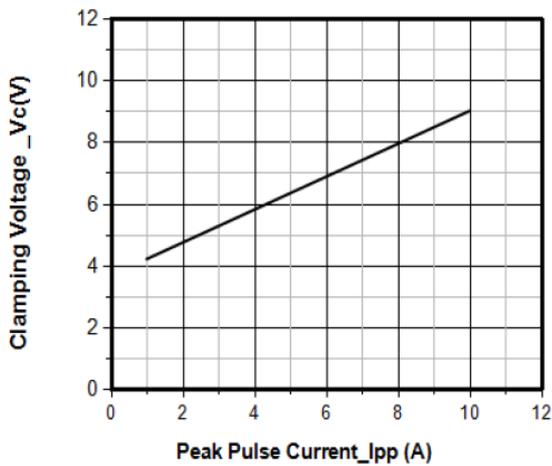
■ Characteristics (Typical)



Junction Capacitance vs. Reverse Voltage



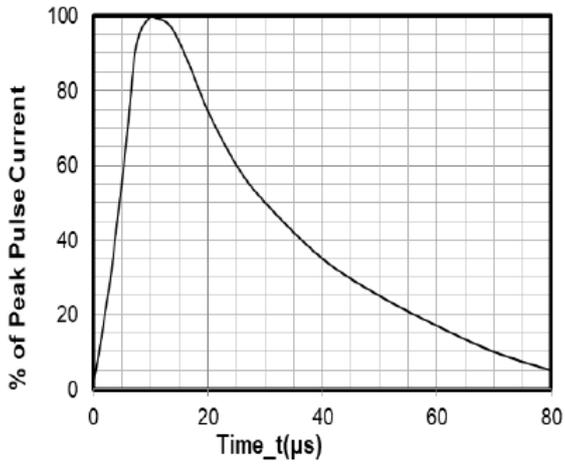
Peak Pulse Power vs. Pulse Time



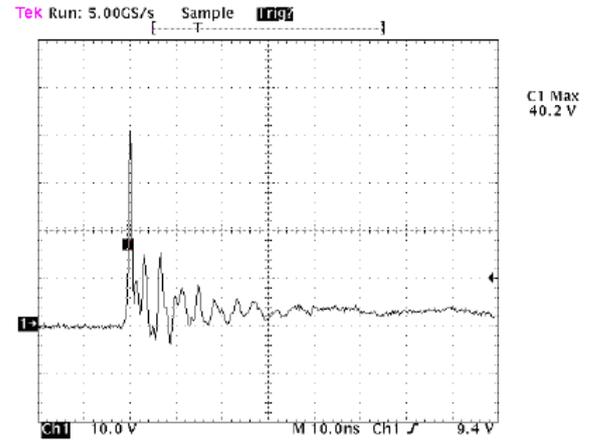
Power Derating Curve



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8 X 20 μ s Pulse Waveform

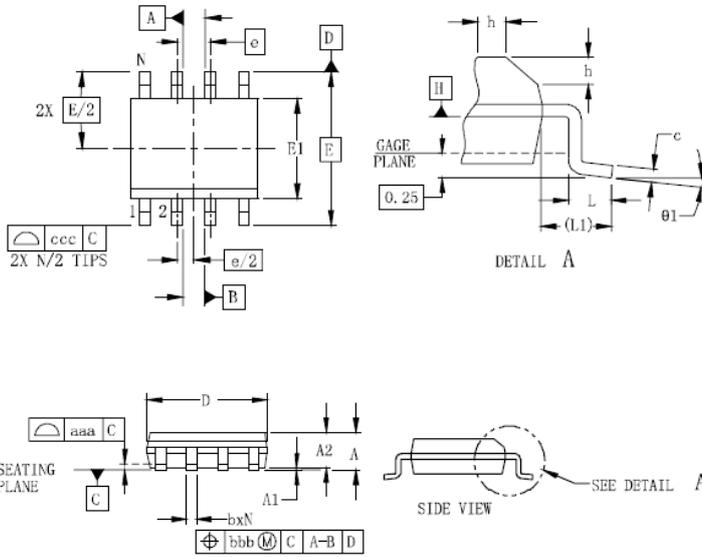


Note: Data is taken with a 10x attenuator
ESD Clamping Voltage
8 kV Contact per IEC61000-4-2



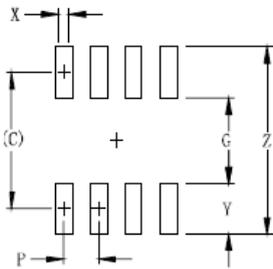
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■ Outline Dimensions



SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
M	MIN	NOM	MAX	MIN	NOM	MAX
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.004		0.010
A2	1.25		1.65	0.049		0.065
b	0.31		0.51	0.012		0.020
c	0.17		0.25	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
E1	3.80	3.90	4.00	0.150	0.154	0.157
E	6.00 BSC			0.236 BSC		
e	1.27 BSC			0.050 BSC		
h	0.25		0.50	0.010		0.020
L	0.40	0.72	1.04	0.016	0.028	0.041
L1	(1.04)			(0.041)		
N	8			8		
theta1	0°		8°	0°		8°
aa	0.10			0.004		
bb	0.25			0.010		
ccc	0.20			0.008		

■ Soldering Footprint



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
C	(5.20)	0.205
G	3.00	0.118
P	1.27	0.050
X	0.60	0.024
Y	2.20	0.087
Z	7.40	0.291



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Disclaimer

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